

Features

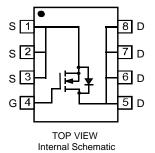
- Low On-Resistance
 - 18mΩ @ V_{GS} = 10V
 - 30mΩ @ V_{GS} = 4.5V
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Lead Free By Design/RoHS Compliant (Note 2)
- "Green" Device (Note 4)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals Connections: See Diagram
- Terminals: Finish Matte Tin annealed over Copper lead frame. Solderable per MIL-STD-202, Method 208
- Marking Information: See Page 4
- Ordering Information: See Page 4
- Weight: 0.072g (approximate)

SO-8





Maximum Ratings @T_A = 25°C unless otherwise specified

Cha	acteristic		Symbol	Value	Units
Drain-Source Voltage			V _{DSS}	30	V
Gate-Source Voltage			V _{GSS}	±25	V
Drain Current (Note 1)	Steady State	T _A = 25°C T _A = 70°C	ID	9 6.75	A
Pulsed Drain Current (Note 3)			I _{DM}	40	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 1)	PD	2.5	W
Thermal Resistance, Junction to Ambient	$R_{ ext{ heta}JA}$	50	°C/W
Operating and Storage Temperature Range	T _{J,} T _{STG}	-55 to +150	°C

Notes: 1. Device mounted on 2 oz copper pad layout with $R_{0JA} = 50^{\circ}C/W$.

2. No purposefully added lead.

3. Pulse width $\leq 10\mu$ S, Duty Cycle $\leq 1\%$.

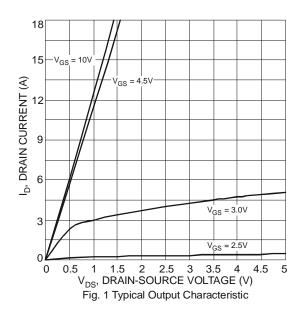
4. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.

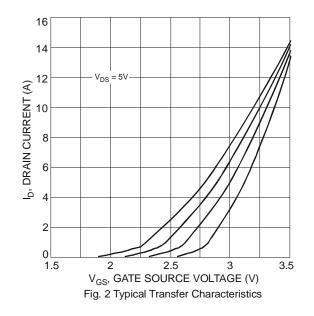


Electrical Characteristics @T_A = 25°C unless otherwise specified

			_				
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 5)		i		i	i	1	
Drain-Source Breakdown Voltage	BV _{DSS}	30	—		V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}		—	1	μΑ	$V_{DS} = 30V, V_{GS} = 0V$	
Gate-Source Leakage	1	_		±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
Gale-Source Leakage	I _{GSS}			±1	μΑ	$V_{GS} = \pm 25V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 5)			÷				
Gate Threshold Voltage	V _{GS(th)}	1	—	2.1	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	
Static Drain-Source On-Resistance			15.7	18	mΩ	$V_{GS} = 10V, I_D = 9A$	
Static Dialit-Source Off-Resistance	R _{DS (ON)}	_	26.4	30	1112.2	$V_{GS} = 4.5V, I_D = 7A$	
Forward Transconductance	g fs	_	5.8		S	$V_{DS} = 10V, I_D = 9A$	
Diode Forward Voltage (Note 5)	V _{SD}	0.5	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 2.1A$	
DYNAMIC CHARACTERISTICS							
Input Capacitance	Ciss	_	741		pF	V _{DS} = 15V, V _{GS} = 0V f = 1.0MHz	
Output Capacitance	Coss	—	124	_	pF		
Reverse Transfer Capacitance	C _{rss}	_	95		pF	1 = 1.00012	
Gate Resistance	R _G	0.30	0.88	1.5	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
SWITCHING CHARACTERISTICS						-	
Tatal Cata Charge	0	_	7.6	12	nC	$V_{DS} = 15V, V_{GS} = 4.5V, I_D = 9A$	
Total Gate Charge	Qg	_	16.7	25		V _{DS} = 15V, V _{GS} = 10V, I _D = 9A	
Gate-Source Charge	Q _{gs}	—	1.9	_			
Gate-Drain Charge	Q _{gd}	_	5.2	_			
Turn-On Delay Time	t _{d(on)}	_	4.0			V _{GS} = 10V, V _{DS} = 15V,	
Rise Time	tr	_	4.4				
Turn-Off Delay Time	t _{d(off)}		23.0		ns	$R_L = 15\Omega, R_G = 6\Omega$	
Fall Time	t _f		9.4	—	1		

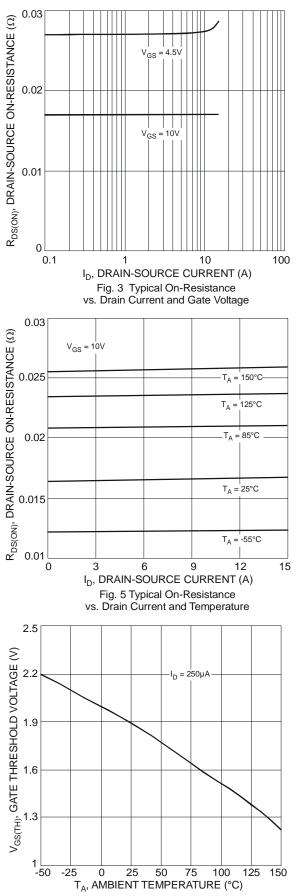
Notes: 5. Short duration pulse test used to minimize self-heating effect.



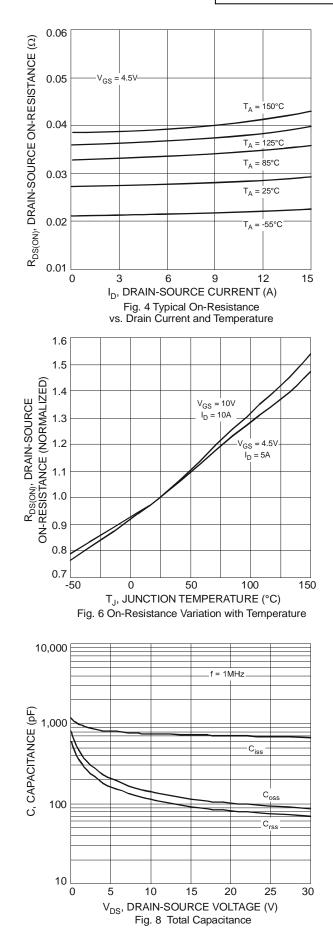


DMN3030LSS



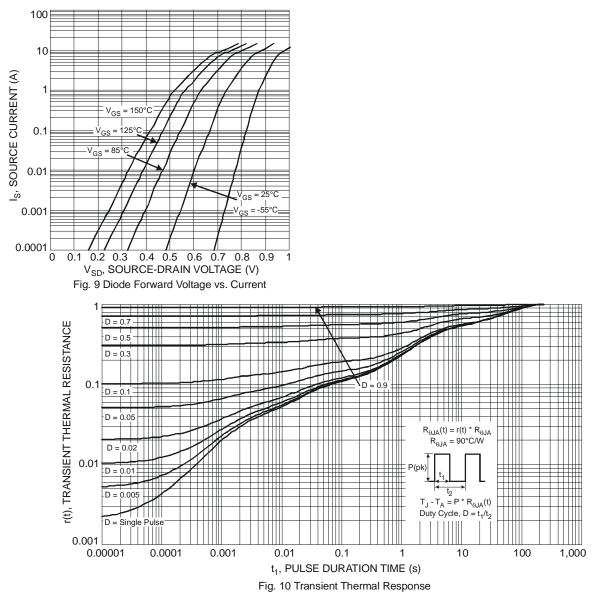










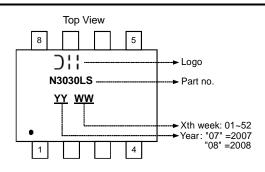


Ordering Information (Note 6)

Part Number	Case	Packaging
DMN3030LSS-13	SO-8	2500/Tape & Reel

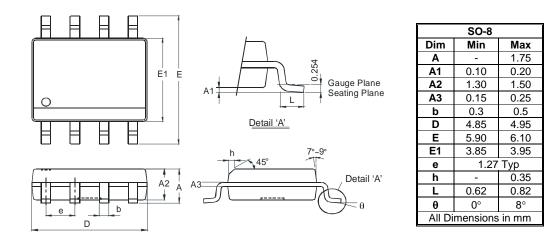
Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information

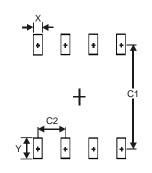




Package Outline Dimensions



Suggested Pad Layout



Dimensions	Value (in mm)
Х	0.60
Y	1.55
C1	5.4
C2	1.27



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